



Preliminary

- Low-loss 815 MHz Filter
- Complies with Directive 2002/95/EC (RoHS)

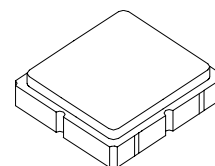


Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	+10	dBm
DC Voltage on any Non-ground Terminal	5	V
Operating Temperature Range	-30 to +80	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 cycles/10 seconds maximum	265	°C

SF2214E

815.00 MHz
SAW Filter



SM3030-6

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_c			815.00		MHz
Insertion Loss, 805 to 825 MHz	IL			2.8	3.5	dB
Peak-to-Peak Amplitude Ripple, 805 to 825 MHz				1.0	2.0	dB
Input/Output VSWR, 805 to 825 MHz	SWR			1.9:1	2.5:1	
Attenuation, Referenced to 0 dB:						dB
10 to 780 MHz			40	63		
851 to 856 MHz			28	50		
856 to 869 MHz			40	47		
869 to 896 MHz			52	45		
896 to 941MHz			40	62		
960 to 2200 MHz			40	46		
2200 to 2600 MHz			30	35		
Source Impedance	Z_S			50		Ω
Load Impedance	Z_L			50		Ω
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	950, YWWS					
Standard Reel Quantity	Reel Size 7 inch	500 Pieces/Reel				
	Reel Size 13 inch	3000 Pieces/Reel				

Electrical Connections

Connection	Terminals
Input	2
Output	5
Case Ground	All others



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

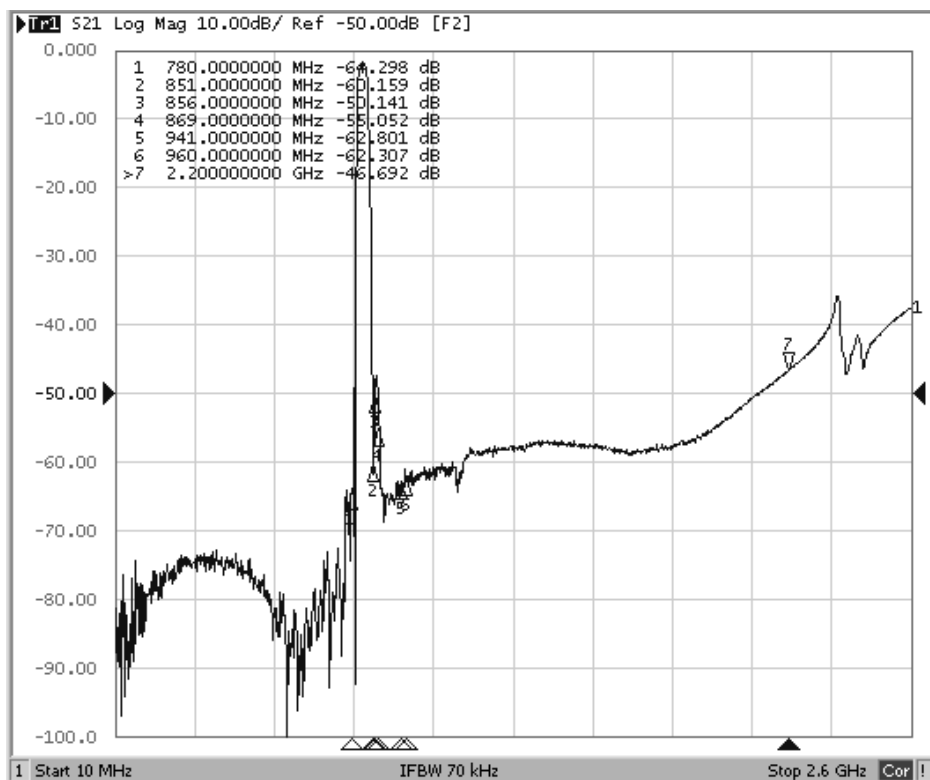
Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_c .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.

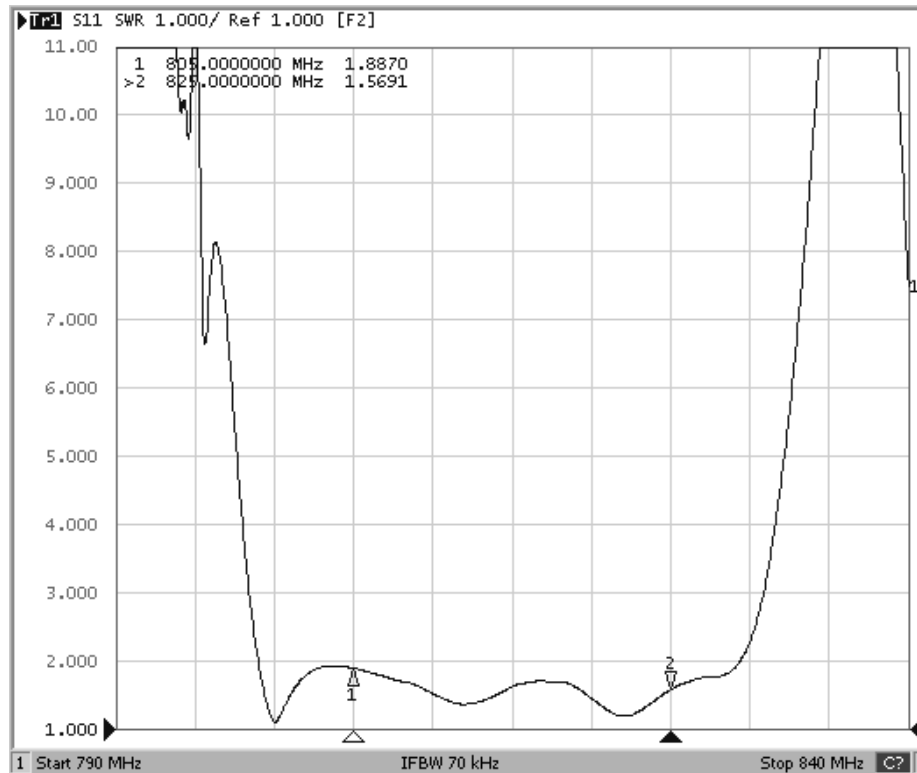
Filter Passband Response



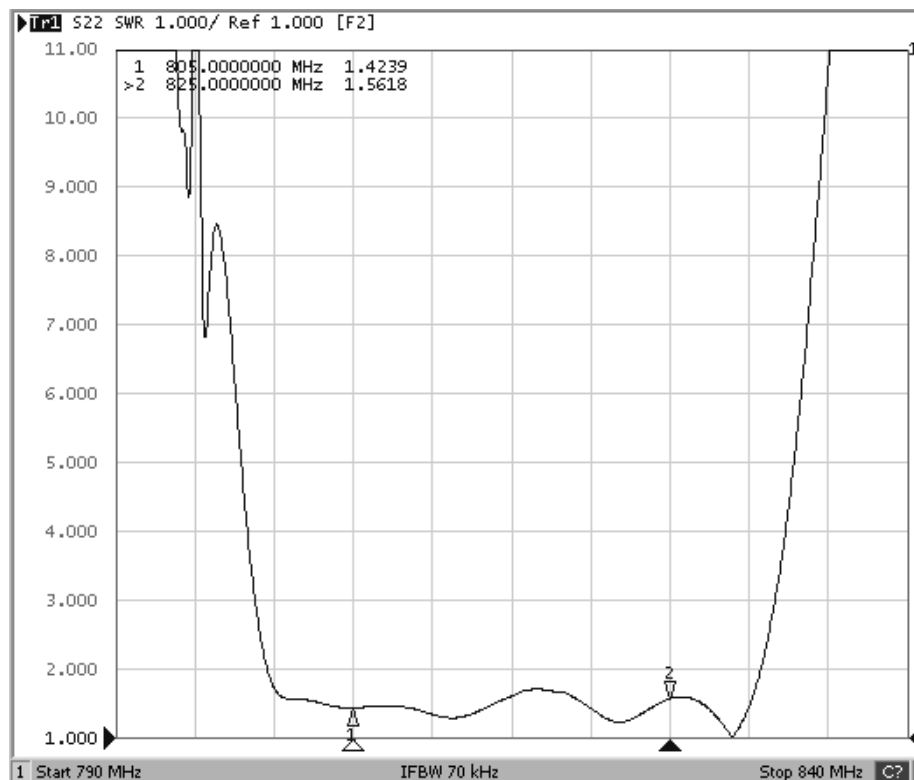
Filter Broadband Response



Filter Input VSWR Plot

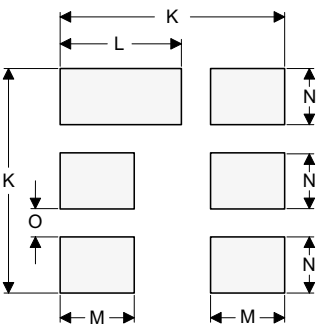
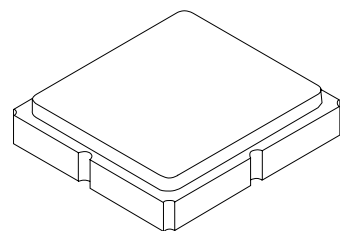


Filter Output VSWR Plot



SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

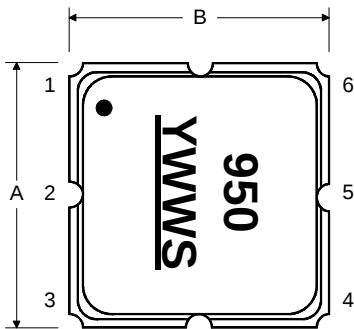
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		1.05			0.041	
N		0.81			0.032	
O		0.38			0.015	

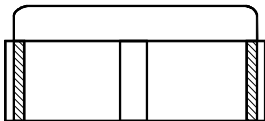
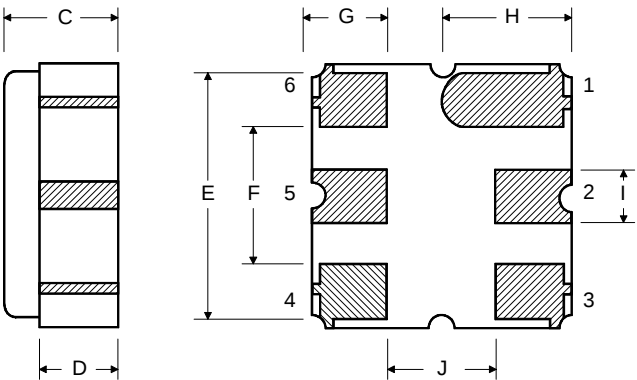
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic
Pb Free	

TOP VIEW



BOTTOM VIEW



Technical drawing of a circular component, likely a flange or end plate, showing three views: a top view, a side view, and a detail view.

Top View: A large circle with a smaller concentric circle in the center. A horizontal dashed line and a vertical dashed line intersect at the center. A leader line points from the text "See Detail 'A'" to the center of the inner circle.

Side View: A vertical cross-section showing the thickness of the component. The total thickness is dimensioned as 12.0. The inner hole has a diameter of 100 REF. The outer diameter is dimensioned as "B" REF.

Detail View (Detail A): A cross-section of the central hole. It shows a circular hole with a diameter of 13.0. The hole is surrounded by a flange with a thickness of 2.0. The outer diameter of the flange is dimensioned as 20.2.

“B”		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm

